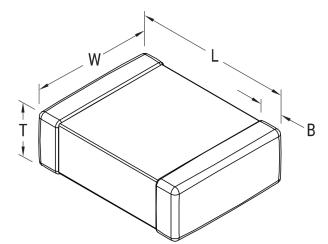


C2225C334K2RAC7210

SMD Comm X7R, Ceramic, 0.33 uF, 10%, 200 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 2225



Click here for the 3D model.

Dimensions	
Chip Size	2225
L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
Т	1.1mm +/-0.15mm
В	0.6mm +/-0.35mm

Packaging Specifications	
Plastic Tape	

General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	310 mg
Shelf Life	78 Weeks
MSL	1

Specifications			
Capacitance	0.33 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	10%		
Voltage DC	200 VDC		
Dielectric Withstanding Voltage	500 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	X7R		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms		
Dissipation Factor	2.5% 1 kHz 1.0Vrms		
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours		
Insulation Resistance	3.0303 GOhms		

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.